

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT5899875

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHENG-CHE LEE	12/13/2019
LIN-CHIEN CHEN	12/13/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HELIOS BIOELECTRONICS INC.
<b>Street Address:</b>	RM. R307, 3F., NO.2, SEC. 2, SHENGYI RD.
<b>Internal Address:</b>	HSINCHU COUNTY
<b>City:</b>	ZHUBEI CITY
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	30261
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16736475
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)628-8844
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2026242500
<b>Email:</b>	edocket@crowell.com, nbrown@crowell.com
<b>Correspondent Name:</b>	CROWELL & MORING LLP
<b>Address Line 1:</b>	P.O. BOX 14300
<b>Address Line 4:</b>	WASHINGTON, D.C. 20044-4300
<b>ATTORNEY DOCKET NUMBER:</b>	115003.PB940US
<b>NAME OF SUBMITTER:</b>	MARY ANNE SCHOFIELD
<b>SIGNATURE:</b>	/Mary Anne Schofield/
<b>DATE SIGNED:</b>	01/08/2020
<b>Total Attachments: 2</b>	
source=PB940US_Assignment#page1.tif	
source=PB940US_Assignment#page2.tif	

## ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto:

**Helios Bioelectronics Inc.**

(hereinafter ASSIGNEE) all right, title and interest in and to his/her invention relating to:

### **METHOD FOR MULTI-LEVEL ETCH, SEMICONDUCTOR SENSING DEVICE, AND METHOD FOR MANUFACTURING SEMICONDUCTOR SENSING DEVICE**

in any form or embodiment thereof, in the United States and all foreign countries, including applications for patents in all countries through the world and through the Patent Cooperation Treaty and/or the European Patent Convention, as set forth in his/her United States Patent Application (check one):

- executed concurrently
- herewith, executed on \_\_\_\_\_,
- Application No. \_\_\_\_\_, filed \_\_\_\_\_
- PCT International Application, No.: \_\_\_\_\_, filed \_\_\_\_\_

and in and to said United States Patent Application including any and all divisions or continuations thereof and in and to any and all Letters Patent of the United States which may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made;

Each of the undersigned hereby authorizes and requests the Director of the U.S. Patent and Trademark Office to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

Each of the undersigned warrants and covenants that he/she has the full and unencumbered right to sell and assign the interests herein sold and assigned and that he/she has not executed and will not execute any document or instrument in conflict herewith;

Each of the undersigned further covenants and agrees he/she will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him/her relating to said invention or Patent application and that he/she will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary

or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention;

Signature: Cheng-Che Lee 12/13. 2019  
Inventor one: Cheng-Che LEE DATE

Signature: Lin-Chien Chen 12/13 2019  
Inventor two: Lin-Chien CHEN DATE